

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3762144

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SIDDHARTHA MALLIK	01/15/2016
TAO LUO	01/15/2016
JING JIANG	01/18/2016
TINGFANG JI	01/20/2016
KRISHNA KIRAN MUKKAVILLI	01/16/2016
NAGA BHUSHAN	01/14/2016
JOSEPH BINAMIRA SORIAGA	01/19/2016
KAMBIZ AZARIAN YAZDI	01/15/2016
PETER GAAL	01/14/2016
JOHN EDWARD SMEE	01/20/2016
CHIH PING LI	01/14/2016

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14968376

CORRESPONDENCE DATA**Fax Number:** (214)855-8200*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.***Phone:** 214-855-8000**Email:** lisa.decordova@nortonrosefulbright.com**Correspondent Name:** NORTON ROSE FULBRIGHT US LLP**Address Line 1:** 2200 ROSS AVENUE**Address Line 2:** SUITE 3600**Address Line 4:** DALLAS, TEXAS 75201

PATENT

ATTORNEY DOCKET NUMBER:	QLXX/P1054US/11510788
NAME OF SUBMITTER:	THOMAS J. MEANEY
SIGNATURE:	/Thomas J. Meaney/
DATE SIGNED:	03/01/2016
Total Attachments: 4 source=QLXXP1054US#page1.tif source=QLXXP1054US#page2.tif source=QLXXP1054US#page3.tif source=QLXXP1054US#page4.tif	

ASSIGNMENT

WHEREAS, WE,

1. **Siddhartha Mallik**, a citizen of India, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
2. **Tao Luo**, a citizen of United States, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
3. **Jing Jiang**, a citizen of China, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
4. **Tingfang Ji**, a citizen of United States, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
5. **Krishna Kiran Mukkavilli**, a citizen of United States, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
6. **Naga Bhushan**, a citizen of United States, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
7. **Joseph Binamira Soriaga**, a citizen of United States, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
8. **Kambiz Azarian Yazdi**, a citizen of United States, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
9. **Peter Gaal**, a citizen of United States, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
10. **John Edward Smee**, a citizen of Canada, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,
11. **Chih Ping Li**, a citizen of Taiwan, having a mailing address located at 5775 Morehouse Road, San Diego, CA 92121-1714 and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to MITIGATION OF BURSTY INTERFERENCE (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to

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said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/968,376 filed December 14, 2015, Qualcomm Reference No. 150184, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/092,035, filed December 15, 2014, Qualcomm Reference No. 150184P1 and 62/133,383, filed March 15, 2015, Qualcomm Reference No. 152601P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;


AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages

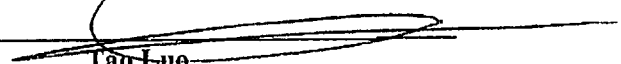
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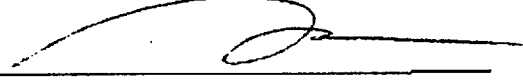
and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;


AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

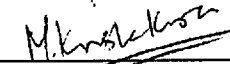
AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.


Done at San Diego, on 01/15/2016 
LOCATION DATE Siddhartha Mallik

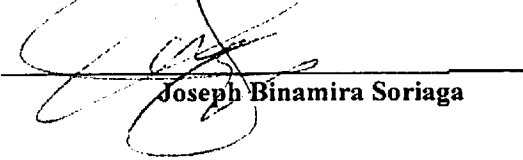
Done at San Diego, on 01/15/2016 
LOCATION DATE Tao Luo

Done at San Diego, on 1/18/2016 
LOCATION DATE Jing Jiang

Done at San Diego, on 1/20/2016 
LOCATION DATE Tingfang Ji

Done at San Diego, on 1/14/2016 
LOCATION DATE Krishna Kiran Mukkavilli

Done at SAN DIEGO, on 1/14/2016 
LOCATION DATE Naga Bhushan


Done at San Diego, on 1/19/2016 
LOCATION DATE Joseph Binamira Soriaga

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 01/15/2016
LOCATION DATE


Kambiz Azarian Yazdi

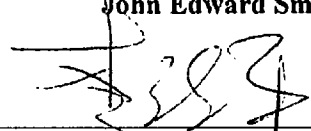
Done at San Diego, on 01/14/2016
LOCATION DATE


Peter Gaal

Done at SAN DIEGO, on 1/20/2016
LOCATION DATE


John Edward Smee

Done at San Diego, on 1/14/2016
LOCATION DATE


Chih Ping Li

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